

BCP55-16-QX Datasheet



DiGi Electronics Part Number	BCP55-16-QX-DG
Manufacturer	Nexperia USA Inc.
Manufacturer Product Number	BCP55-16-QX
Description	TRANS NPN 60V 1A SOT223
Detailed Description	Bipolar (BJT) Transistor NPN 60 V 1 A 180MHz 650 mW Surface Mount SOT-223

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Purchase and inquiry

Manufacturer Product Number:

BCP55-16-QX

Series:

BCP55-Q

Transistor Type:

NPN

Voltage - Collector Emitter Breakdown (Max):

60 V

Current - Collector Cutoff (Max):

100nA (ICBO)

Power - Max:

650 mW

Operating Temperature:

150°C (TJ)

Qualification:

AEC-Q101

Package / Case:

TO-261-4, TO-261AA

Base Product Number:

BCP55

Manufacturer:

Nexperia USA Inc.

Product Status:

Active

Current - Collector (Ic) (Max):

1 A

Vce Saturation (Max) @ Ib, Ic:

500mV @ 50mA, 500mA

DC Current Gain (hFE) (Min) @ Ic, Vce:

100 @ 150mA, 2V

Frequency - Transition:

180MHz

Grade:

Automotive

Mounting Type:

Surface Mount

Supplier Device Package:

SOT-223

Environmental & Export classification

RoHS Status:

ROHS3 Compliant

REACH Status:

REACH Unaffected

HTSUS:

8541.21.0075

Moisture Sensitivity Level (MSL):

1 (Unlimited)

ECCN:

EAR99



BCP55-Q series

60 V, 1 A NPN medium power transistors

Rev. 2 — 1 July 2022

Product data sheet

1. General description

NPN medium power transistor series in a small SOT223 (SC-73) Surface-Mounted Device (SMD) plastic package.

Table 1. Product overview

Type number	Package		NPN complement
	Nexperia	JEITA	
BCP55-Q	SOT223	SC73	BCP52-Q
BCP55-10-Q			BCP52-10-Q
BCP55-16-Q			BCP52-16-Q

2. Features and benefits

- High current
- Three current gain selections
- High power dissipation capability
- Qualified according to AEC-Q101 and recommended for use in automotive applications

3. Applications

- Linear voltage regulators
- Power management
- Low-side switches
- MOSFET drivers
- Battery-driven devices
- Amplifiers

4. Quick reference data

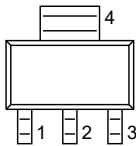
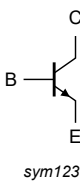
Table 2. Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{CE0}	collector-emitter voltage	open base	-	-	60	V
I_C	collector current		-	-	1	A
I_{CM}	peak collector current	single pulse; $t_p \leq 1$ ms	-	-	2	A
h_{FE}	DC current gain					
	BCP55-Q	$V_{CE} = 2$ V; $I_C = 150$ mA $T_{amb} = 25$ °C	[1]	63	-	250
	BCP55-10-Q		[1]	63	-	160
	BCP55-16-Q		[1]	100	-	250

[1] pulsed; $t_p \leq 300$ μ s; $\delta \leq 0.02$

5. Pinning information

Table 3. Pinning

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	B	base		
2	C	collector		
3	E	emitter		
4	C	collector		

6. Ordering information

Table 4. Ordering information

Type number	Package		Version
	Name	Description	
BCP55-Q	SC-73	plastic surface-mounted package with increased heatsink; 4 leads	SOT223
BCP55-10-Q			
BCP55-16-Q			

7. Marking

Table 5. Marking

Type number	Marking code
BCP55-Q	BCP55
BCP55-10-Q	BCP55 /10
BCP55-16-Q	BCP55 /16

8. Limiting values

Table 6. Limiting values

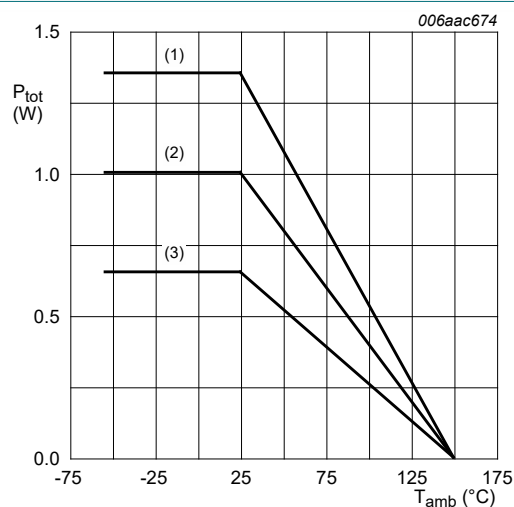
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CBO}	collector-base voltage	open emitter	-	60	V
V_{CEO}	collector-emitter voltage	open base	-	60	V
V_{EBO}	emitter-base voltage	open collector	-	5	V
I_C	collector current		-	1	A
I_{CM}	peak collector current	single pulse; $t_p \leq 1$ ms	-	2	A
I_B	base current		-	0.3	A
I_{BM}	peak base current	single pulse; $t_p \leq 1$ ms	-	0.3	A
P_{tot}	total power dissipation	$T_{amb} \leq 25$ °C [1]	-	0.65	W
		[2]	-	1.00	W
		[3]	-	1.35	W
T_j	junction temperature		-	150	°C
T_{amb}	ambient temperature		-55	150	°C
T_{stg}	storage temperature		-65	150	°C

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated; mounting pad for collector 1 cm².

[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated; mounting pad for collector 6 cm².



- (1) FR4 PCB, mounting pad for collector 6 cm²
 (2) FR4 PCB, mounting pad for collector 1 cm²
 (3) FR4 PCB, standard footprint

Fig. 1. Power derating curves SOT223

9. Thermal characteristics

Table 7. Thermal characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit	
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	-	192	K/W
			[2]	-	-	125	K/W
			[3]	-	-	93	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point		-	-	16	K/W	

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
 [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated; mounting pad for collector 1 cm².
 [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated; mounting pad for collector 6 cm².

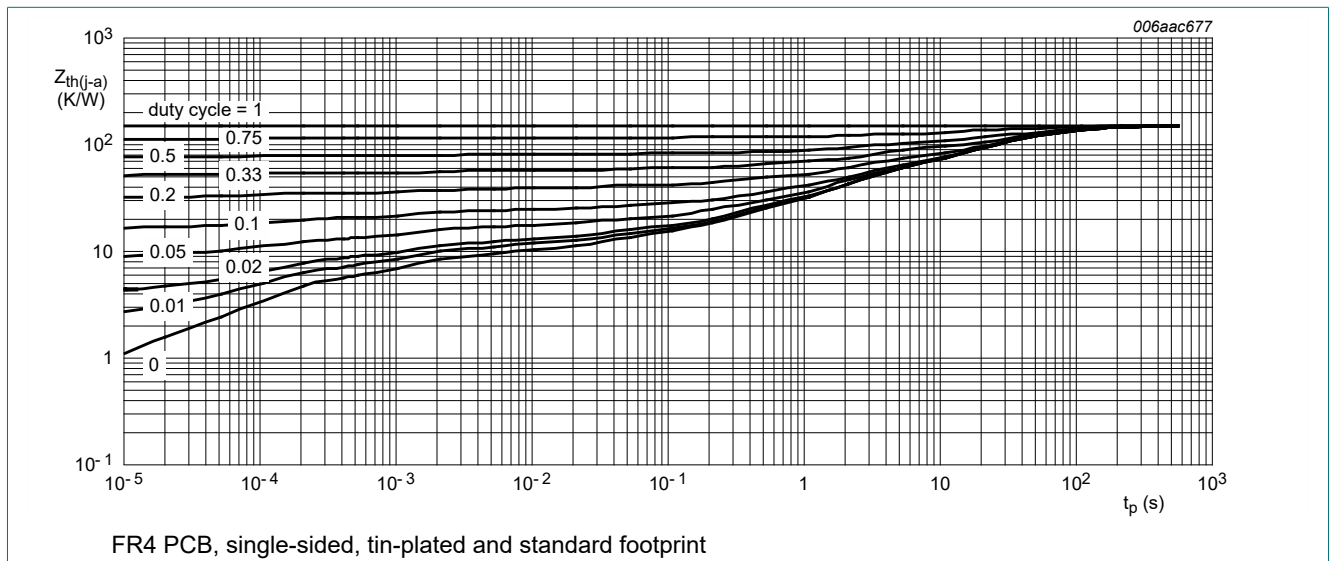


Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

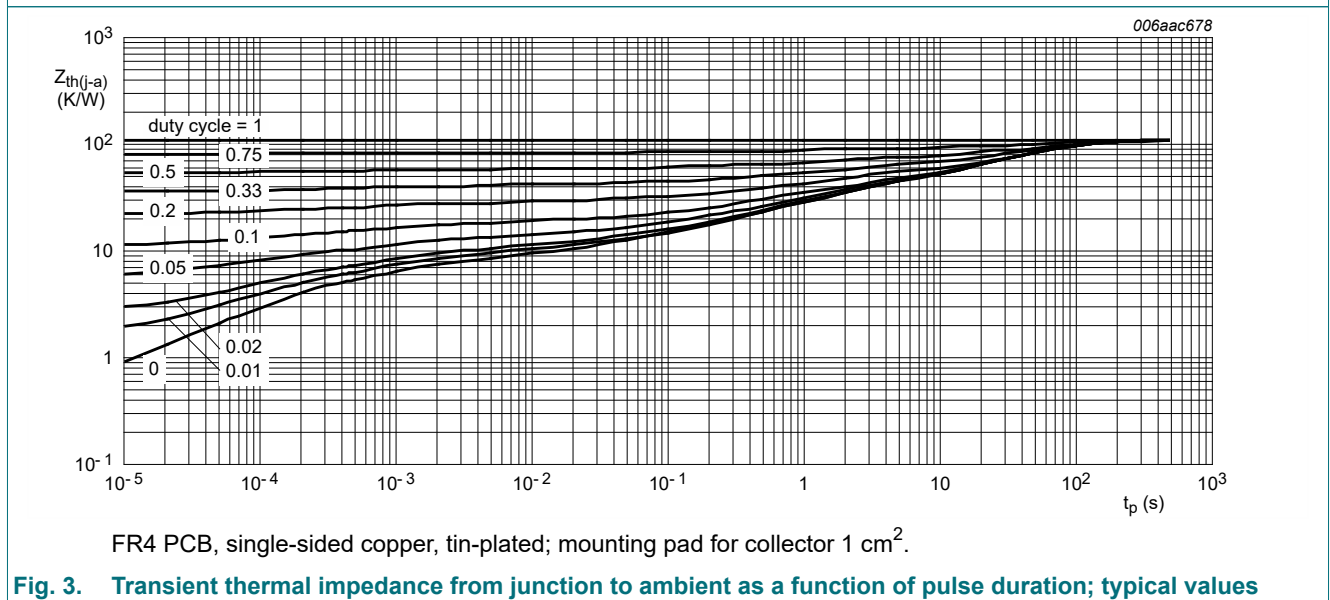
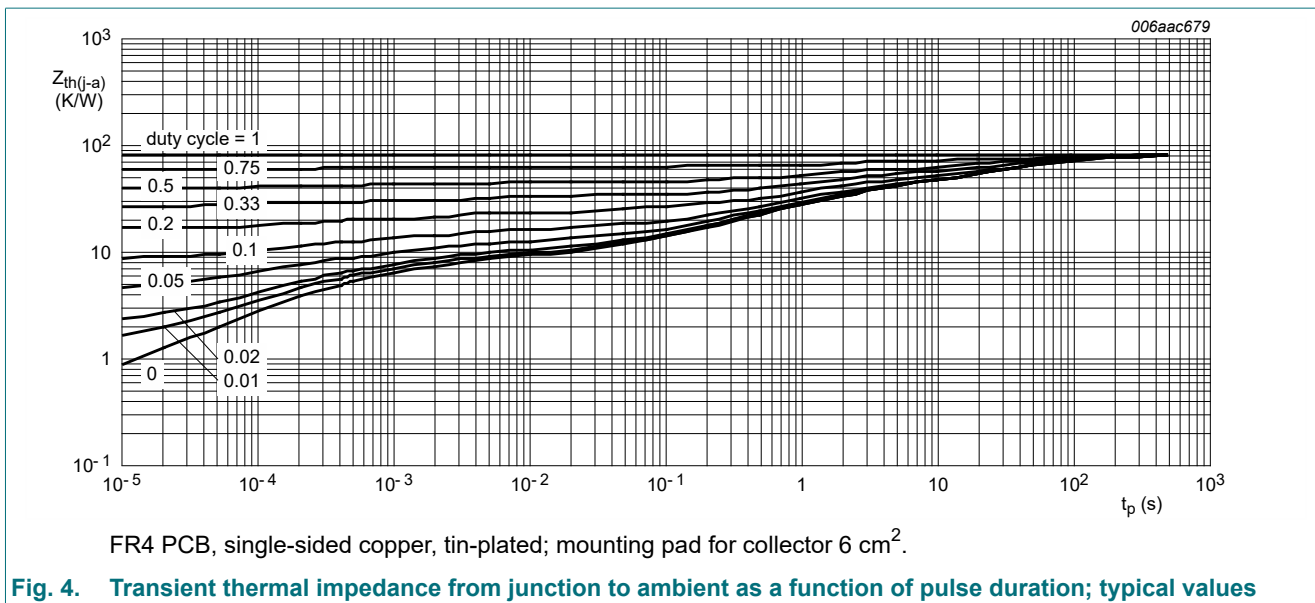


Fig. 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



10. Characteristics

Table 8. Characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$V_{(BR)CBO}$	collector-base breakdown voltage	$I_C = 100 \mu\text{A}; I_E = 0; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$		60	-	-	V
$V_{(BR)CEO}$	collector-emitter breakdown voltage	$I_C = 2 \mu\text{A}; I_B = 0 \text{ A}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$		60	-	-	V
$V_{(BR)EBO}$	emitter-base breakdown voltage	$I_C = 0 \text{ A}; I_E = 100 \mu\text{A}$		5	-	-	V
I_{CBO}	collector-base cut-off current	$V_{CB} = 30 \text{ V}; I_E = 0 \text{ A}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$		-	-	100	nA
		$V_{CB} = 30 \text{ V}; I_E = 0 \text{ A}; T_J = 150 \text{ }^\circ\text{C}$		-	-	10	μA
I_{EBO}	emitter-base cut-off current	$V_{EB} = 5 \text{ V}; I_C = 0 \text{ A}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$		-	-	100	nA
h_{FE}	DC current gain						
	BCP55-Q	$V_{CE} = 2 \text{ V}; I_C = 5 \text{ mA}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$	[1]	63	-	-	
		$V_{CE} = 2 \text{ V}; I_C = 150 \text{ mA}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$	[1]	63	-	250	
		$V_{CE} = 2 \text{ V}; I_C = 500 \text{ mA}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$	[1]	40	-	-	
	BCP55-10-Q	$V_{CE} = 2 \text{ V}; I_C = 5 \text{ mA}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$	[1]	63	-	-	
		$V_{CE} = 2 \text{ V}; I_C = 150 \text{ mA}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$	[1]	63	-	160	
		$V_{CE} = 2 \text{ V}; I_C = 500 \text{ mA}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$	[1]	40	-	-	
	BCP55-16-Q	$V_{CE} = 2 \text{ V}; I_C = 5 \text{ mA}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$	[1]	63	-	-	
		$V_{CE} = 2 \text{ V}; I_C = 150 \text{ mA}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$	[1]	100	-	250	
		$V_{CE} = 2 \text{ V}; I_C = 500 \text{ mA}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$	[1]	40	-	-	
h_{FE}	DC current gain	$V_{CE} = 2 \text{ V}; I_C = 5 \text{ mA}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$	[1]	63	-	-	
h_{FE}	DC current gain	$V_{CE} = 2 \text{ V}; I_C = 500 \text{ mA}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$	[1]	40	-	-	
V_{CEsat}	collector-emitter saturation voltage	$I_C = 500 \text{ mA}; I_B = 50 \text{ mA}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$	[1]	-	-	0.5	V
V_{BE}	base-emitter voltage	$V_{CE} = 2 \text{ V}; I_C = 500 \text{ mA}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$	[1]	-	-	1	V
C_c	collector capacitance	$V_{CB} = 10 \text{ V}; I_E = I_e = 0 \text{ A}; f = 1 \text{ MHz}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$		-	6	-	pF
f_T	transition frequency	$V_{CE} = 5 \text{ V}; I_C = 50 \text{ mA}; f = 100 \text{ MHz}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$		100	180	-	MHz

[1] pulsed; $t_p \leq 300 \mu\text{s}$; $\delta \leq 0.02$

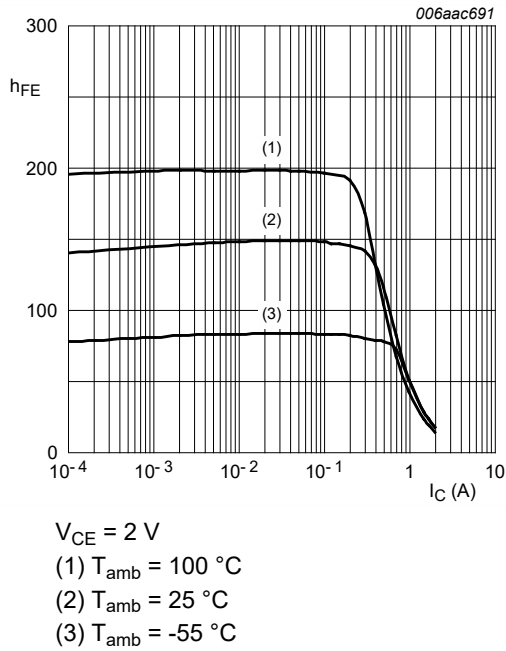


Fig. 5. DC current gain as a function of collector current; typical values

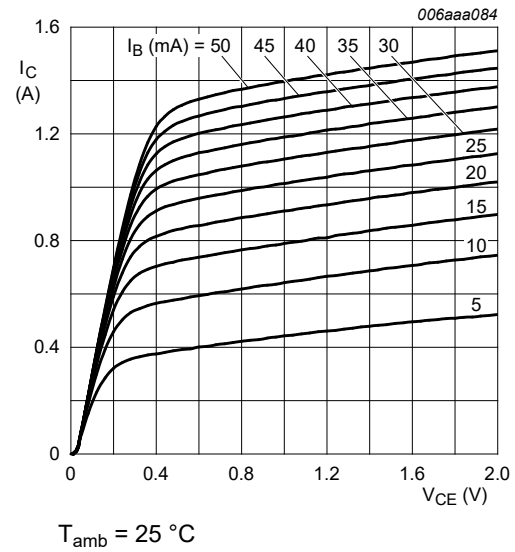


Fig. 6. Collector current as a function of collector-emitter voltage; typical values

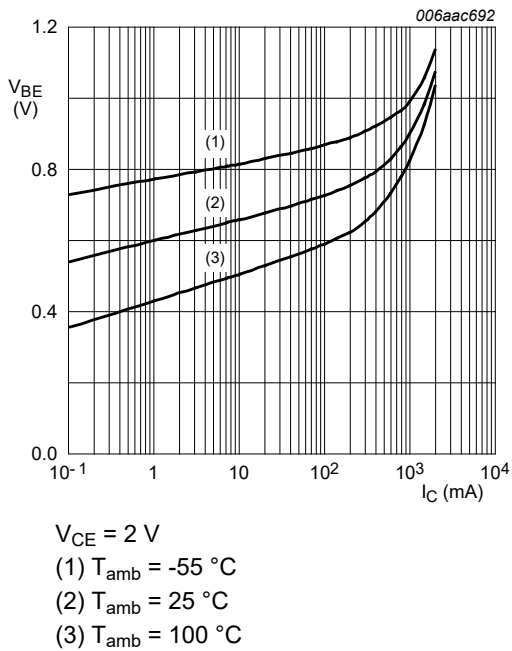


Fig. 7. Base-emitter voltage as a function of collector current; typical values

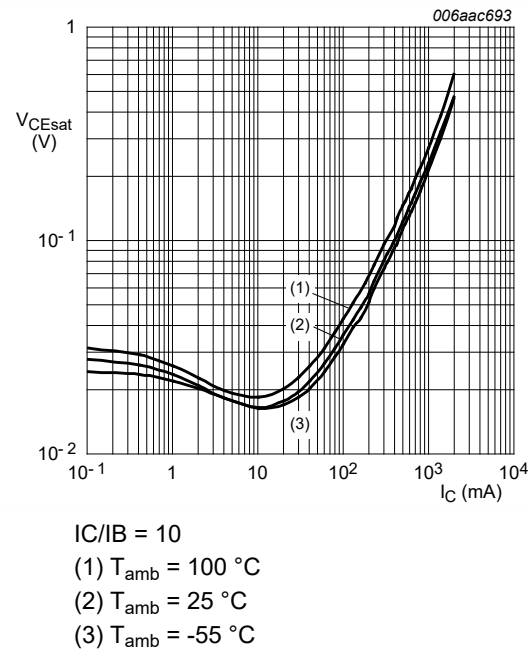


Fig. 8. Collector-emitter saturation voltage as a function of collector current; typical values

11. Test information

11.1. Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

12. Package outline

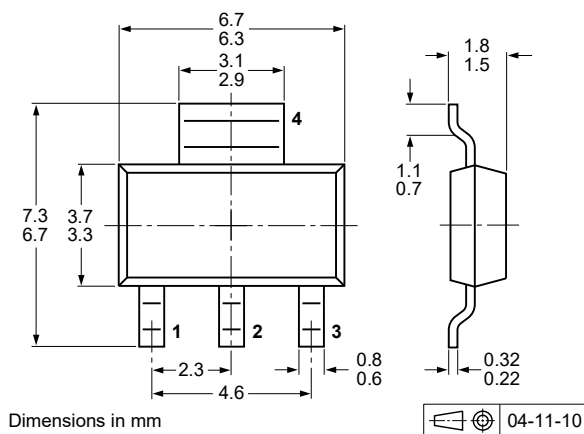
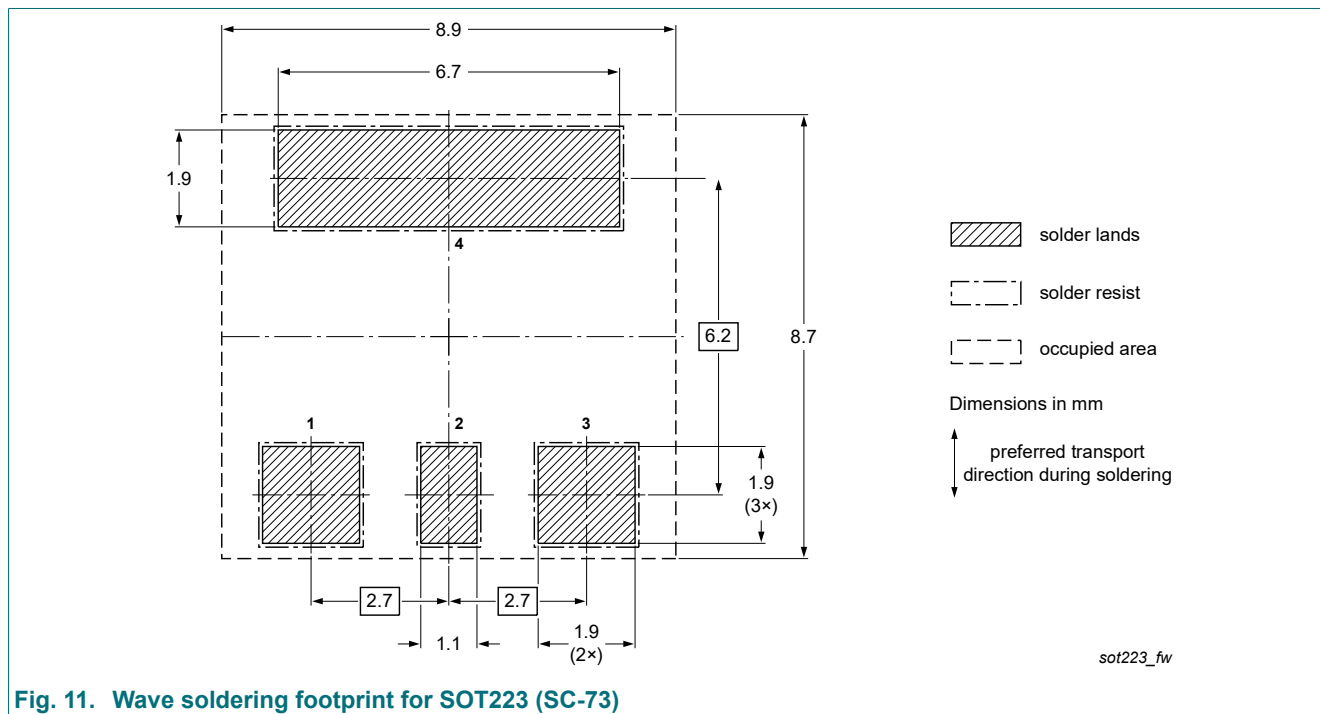
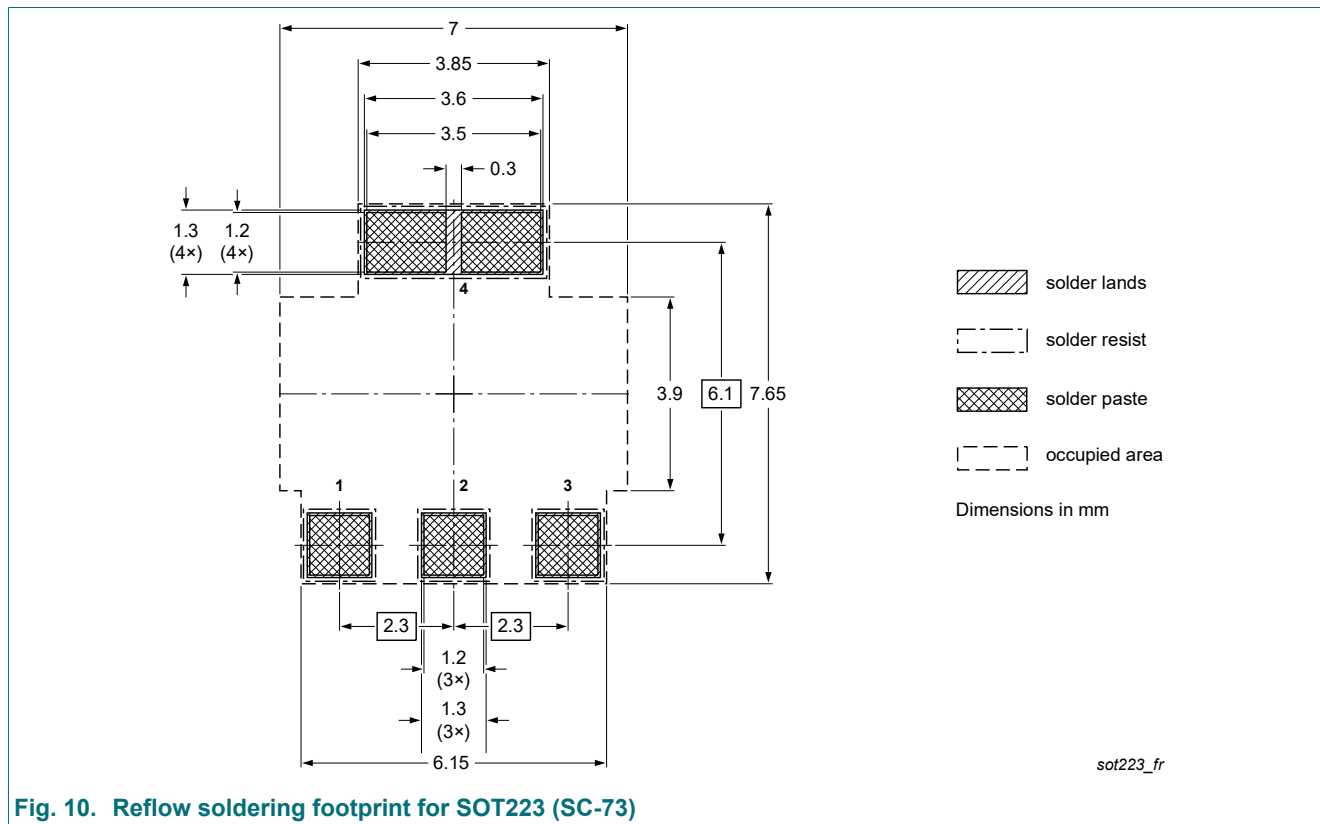


Fig. 9. Package outline SOT223 (SC-73)

13. Soldering



14. Revision history

Table 9. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
BCP55-Q_SER v.2	20220701	Product data sheet	-	BCP55-Q_SER v.1
Modifications:	<ul style="list-style-type: none"> Characteristics at $V_{(BR)CEO}$: Conditions corrected 			
BCP55-Q_SER v.1	20210623	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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